

## PRODUCT FEATURES

- IGBT chip in trench FS-technology
- Low switching losses
- $V_{CE(sat)}$  with positive temperature coefficient
- Fast switching and short tail current
- Free wheeling diodes with fast and soft reverse recovery



## APPLICATIONS

- AC motor control
- Motion/servo control
- Inverter and power supplies

## IGBT-inverter

### ABSOLUTE MAXIMUM RATINGS

$T_C = 25^\circ\text{C}$  unless otherwise specified

Symbol	Parameter/Test Conditions		Values	Unit
$V_{CES}$	Collector Emitter Voltage	$T_J = 25^\circ\text{C}$	1200	V
$V_{GES}$	Gate Emitter Voltage		$\pm 20$	
$I_C$	DC Collector Current	$T_C = 25^\circ\text{C}$	200	A
		$T_C = 80^\circ\text{C}$	150	
$I_{CM}$	Repetitive Peak Collector Current	$t_p = 1\text{ms}$	300	
$P_{tot}$	Power Dissipation Per IGBT		820	W

## Diode-inverter

### ABSOLUTE MAXIMUM RATINGS

$T_C = 25^\circ\text{C}$  unless otherwise specified

Symbol	Parameter/Test Conditions		Values	Unit
$V_{RRM}$	Repetitive Reverse Voltage	$T_J = 25^\circ\text{C}$	1200	V
$I_{F(AV)}$	Average Forward Current	$T_C = 25^\circ\text{C}$	120	A
$I_{FRM}$	Repetitive Peak Forward Current	$t_p = 1\text{ms}$	240	
$i^2t$		$T_J = 125^\circ\text{C}, t = 10\text{ms}, V_R = 0\text{V}$	4050	$\text{A}^2\text{S}$

**IGBT-inverter**  
**ELECTRICAL CHARACTERISTICS**
 $T_C = 25^\circ\text{C}$  unless otherwise specified

Symbol	Parameter/Test Conditions		Min.	Typ.	Max.	Unit
$V_{GE(th)}$	Gate Emitter Threshold Voltage	$V_{CE}=V_{GE}, I_C=6\text{mA}$	5.0	5.8	6.5	V
$V_{CE(sat)}$	Collector Emitter Saturation Voltage	$I_C=150\text{A}, V_{GE}=15\text{V}, T_J=25^\circ\text{C}$		2.2	2.5	
		$I_C=150\text{A}, V_{GE}=15\text{V}, T_J=125^\circ\text{C}$		2.5		
$I_{CES}$	Collector Leakage Current	$V_{CE}=1200\text{V}, V_{GE}=0\text{V}, T_J=25^\circ\text{C}$			100	$\mu\text{A}$
		$V_{CE}=1200\text{V}, V_{GE}=0\text{V}, T_J=125^\circ\text{C}$			1	$\text{mA}$
$I_{GES}$	Gate Leakage Current	$V_{CE}=0\text{V}, V_{GE}=\pm 15\text{V}, T_J=125^\circ\text{C}$	-400		400	$\text{nA}$
$R_{gint}$	Integrated Gate Resistor			0		$\Omega$
$Q_g$	Gate Charge	$V_{CE}=600\text{V}, I_C=150\text{A}, V_{GE}=15\text{V}$		0.8		$\mu\text{C}$
$C_{ies}$	Input Capacitance	$V_{CE}=25\text{V}, V_{GE}=0\text{V}, f=1\text{MHz}$		19		$\text{nF}$
$C_{res}$	Reverse Transfer Capacitance				320	
$t_{d(on)}$	Turn on Delay Time	$V_{CC}=600\text{V}, I_C=150\text{A}$ $R_G=10\Omega,$ $V_{GE}=\pm 15\text{V},$ Inductive Load	$T_J=25^\circ\text{C}$		90	$\text{ns}$
			$T_J=125^\circ\text{C}$		100	$\text{ns}$
$t_r$	Rise Time		$T_J=25^\circ\text{C}$		65	$\text{ns}$
			$T_J=125^\circ\text{C}$		70	$\text{ns}$
$t_{d(off)}$	Turn off Delay Time	$V_{CC}=600\text{V}, I_C=150\text{A}$ $R_G=10\Omega,$ $V_{GE}=\pm 15\text{V},$ Inductive Load	$T_J=25^\circ\text{C}$		450	$\text{ns}$
			$T_J=125^\circ\text{C}$		480	$\text{ns}$
$t_f$	Fall Time		$T_J=25^\circ\text{C}$		50	$\text{ns}$
			$T_J=125^\circ\text{C}$		60	$\text{ns}$
$E_{on}$	Turn on Energy	$V_{CC}=600\text{V}, I_C=150\text{A}$ $R_G=10\Omega,$ $V_{GE}=\pm 15\text{V},$ Inductive Load	$T_J=25^\circ\text{C}$		6	$\text{mJ}$
			$T_J=125^\circ\text{C}$		13.2	$\text{mJ}$
$E_{off}$	Turn off Energy		$T_J=25^\circ\text{C}$		8.5	$\text{mJ}$
			$T_J=125^\circ\text{C}$		9.4	$\text{mJ}$
$I_{sc}$	Short Circuit Current	$t_{psc} \leq 10\mu\text{s}, V_{GE}=15\text{V}$ $T_J=125^\circ\text{C}, V_{CC}=600\text{V}$		600		A
$R_{thJC}$	Junction to Case Thermal Resistance ( Per IGBT )				0.15	$\text{K/W}$

**Diode-inverter**  
**ELECTRICAL CHARACTERISTICS**
 $T_C = 25^\circ\text{C}$  unless otherwise specified

Symbol	Parameter/Test Conditions		Min.	Typ.	Max.	Unit
$V_F$	Forward Voltage	$I_F=120\text{A}, V_{GE}=0\text{V}, T_J=25^\circ\text{C}$		2.4	2.8	V
		$I_F=120\text{A}, V_{GE}=0\text{V}, T_J=125^\circ\text{C}$		2.0		
$t_{rr}$	Reverse Recovery Time	$I_F=120\text{A}, V_R=600\text{V}$		200		$\text{ns}$
$I_{RRM}$	Max. Reverse Recovery Current	$di_F/dt=-1500\text{A}/\mu\text{s}$		135		A
$Q_{RR}$	Reverse Recovery Charge	$T_J=125^\circ\text{C}$		8.5		$\mu\text{C}$
$E_{rec}$	Reverse Recovery Energy				4	$\text{mJ}$
$R_{thJCD}$	Junction to Case Thermal Resistance ( Per Diode )				0.35	$\text{K/W}$

**MODULE CHARACTERISTICS**

*T<sub>C</sub> = 25°C unless otherwise specified*

Symbol	Parameter/Test Conditions		Values	Unit
T <sub>Jmax</sub>	Max. Junction Temperature		150	°C
T <sub>Jop</sub>	Operating Temperature		-40~125	
T <sub>stg</sub>	Storage Temperature		-40~125	
V <sub>isol</sub>	Isolation Breakdown Voltage	AC, 50Hz(R.M.S), t=1minute	3000	V
CTI	Comparative Tracking Index		> 200	
Torque	to heatsink	Recommended (M6)	3~5	Nm
	to terminal	Recommended (M5)	2.5~5	Nm
Weight			160	g

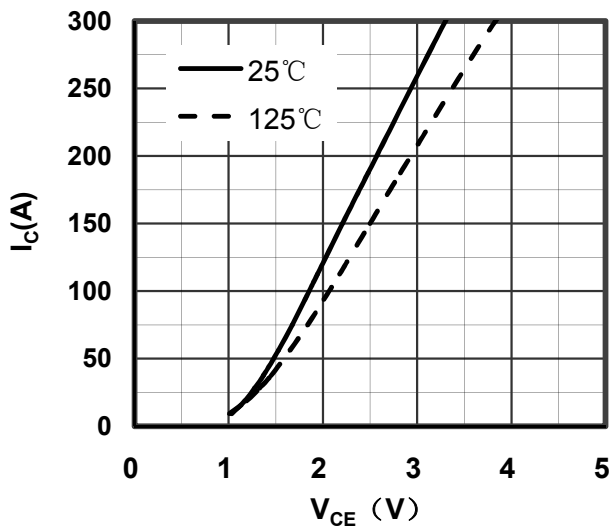


Figure 1. Typical Output Characteristics IGBT-inverter

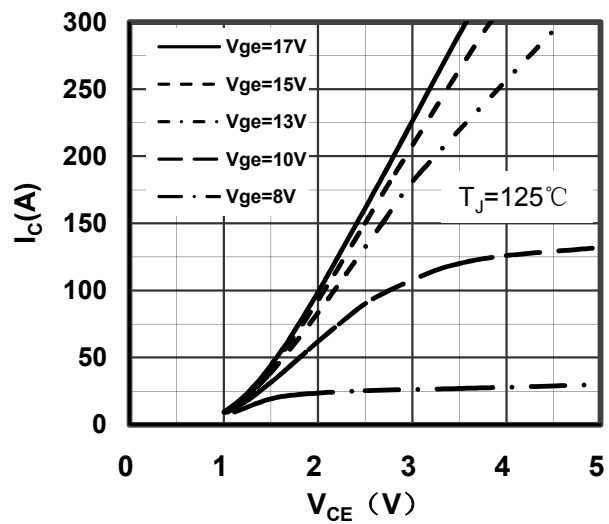


Figure 2. Typical Output Characteristics IGBT-inverter

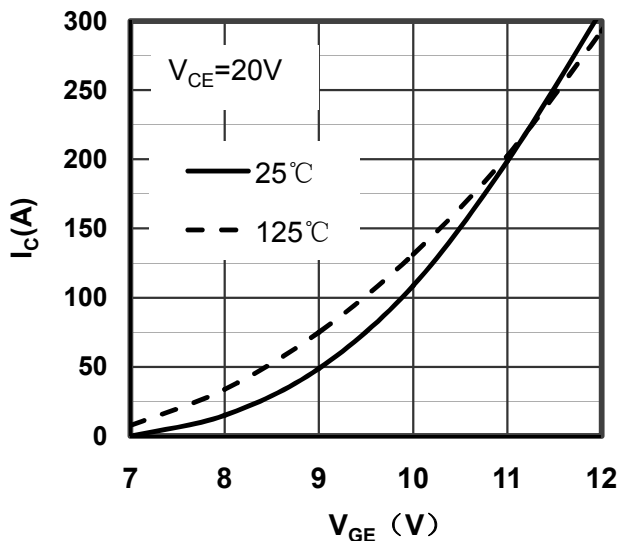


Figure 3. Typical Transfer characteristics IGBT-inverter

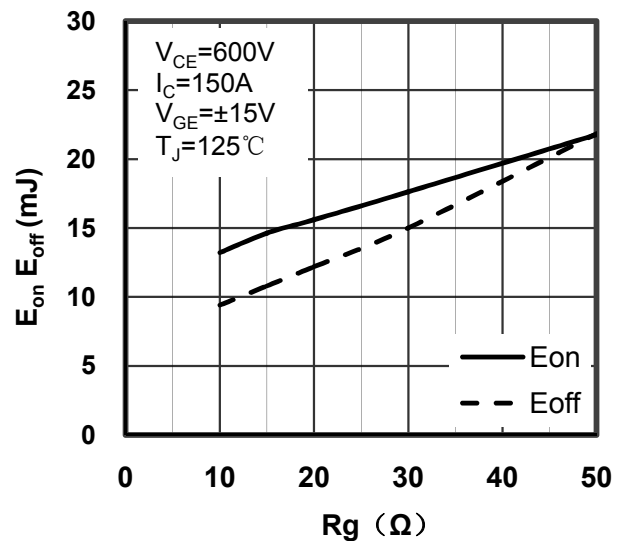


Figure 4. Switching Energy vs Gate Resistor IGBT-inverter

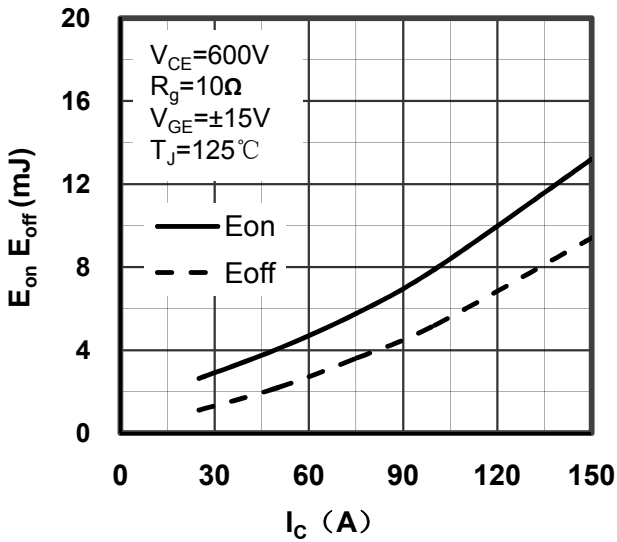


Figure 5. Switching Energy vs Collector Current IGBT-inverter

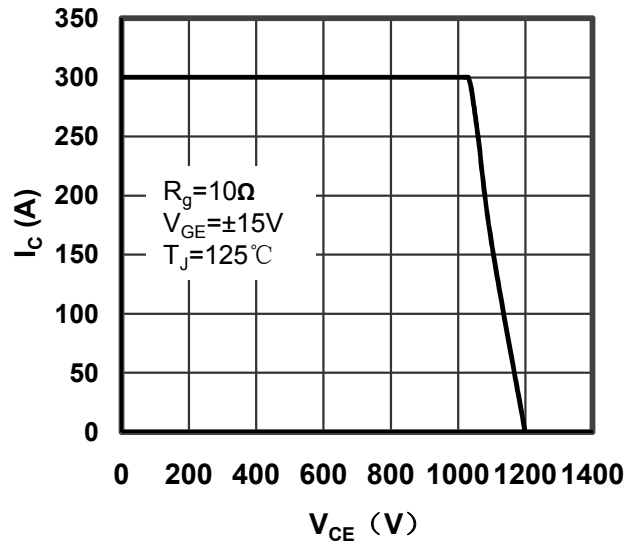


Figure 6. Reverse Biased Safe Operating Area IGBT-inverter

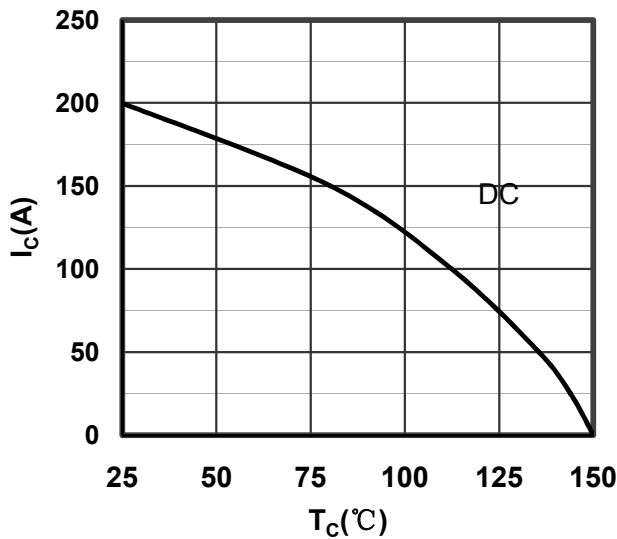


Figure 7. Collector Current vs Case temperature IGBT -inverter

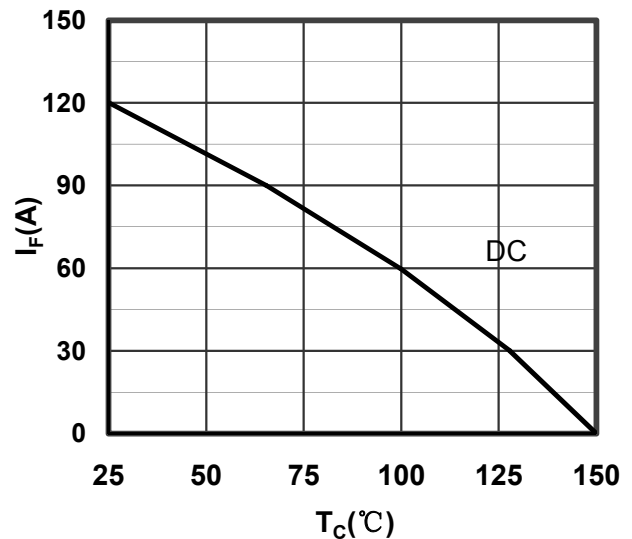


Figure 8. Forward current vs Case temperature Diode -inverter

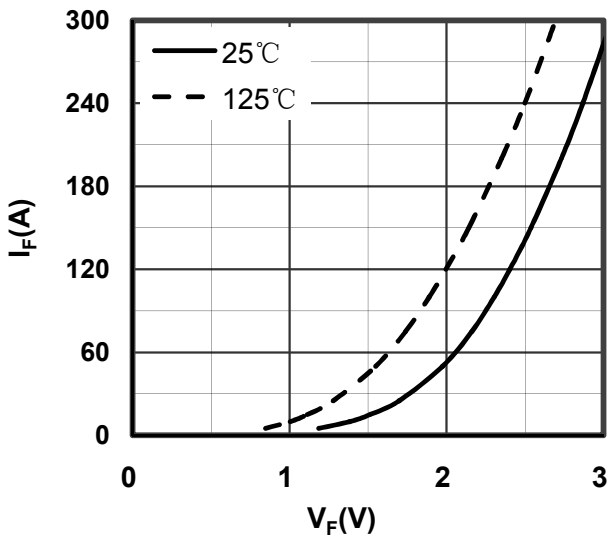


Figure 9. Diode Forward Characteristics Diode -inverter

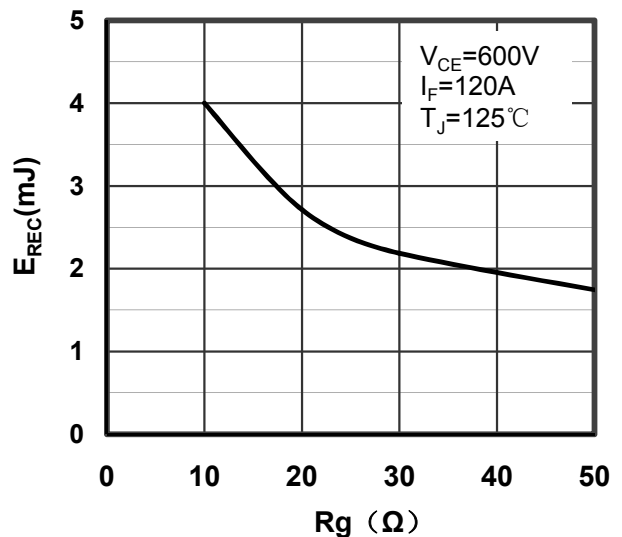


Figure 10. Switching Energy vs Gate Resistor Diode -inverter

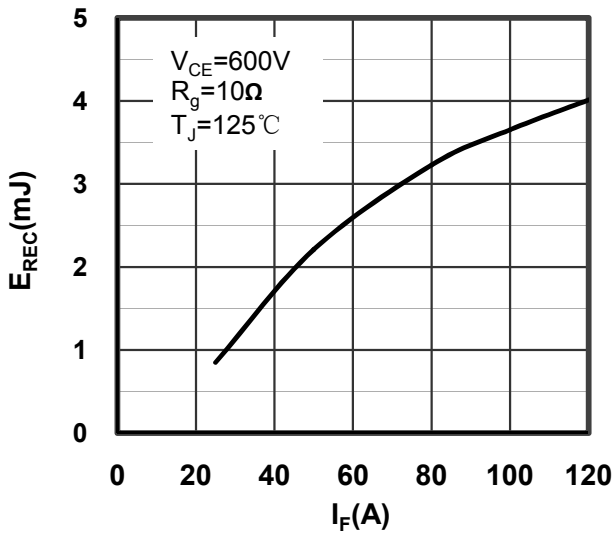


Figure 11. Switching Energy vs Forward Current Diode-inverter

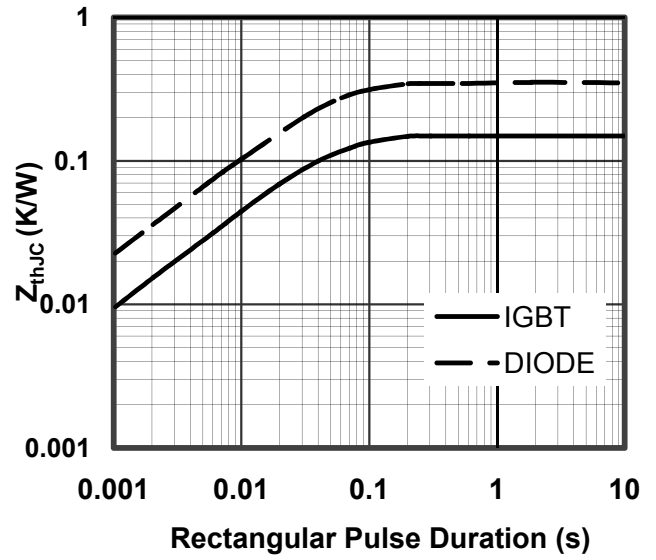


Figure 12. Transient Thermal Impedance of Diode and IGBT-inverter

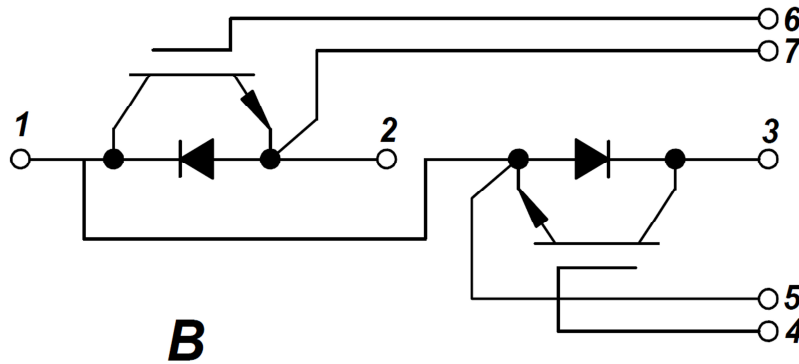
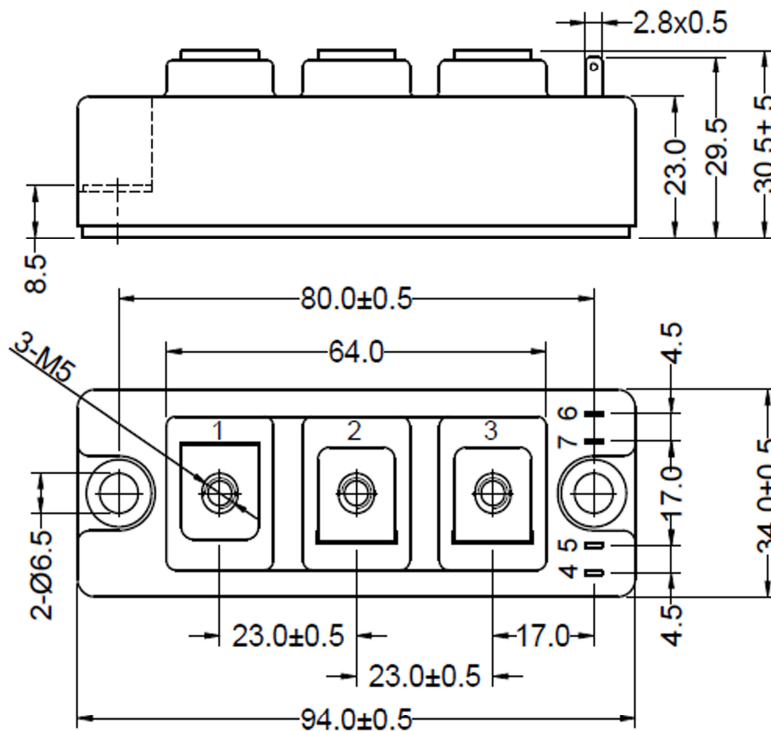


Figure 13. Circuit Diagram



Dimensions in (mm)  
Figure 14. Package Outline